

Interview Summary	Application No.	Applicant(s)	
	10/644,690	STALMANS et al.	
	Examiner	Art Unit	
	Lee, Calvin	2825	

All participants (applicant, applicant's representative, PTO personnel):

(1) Lee Calvin. (3) _____.

(2) Richard E. Campbell. (4) _____.

Date of Interview: 22 June 2004.

Type: a) Telephonic b) Video Conference
c) Personal [copy given to: 1) applicant 2) applicant's representative]

Exhibit shown or demonstration conducted: d) Yes e) No.
If Yes, brief description: _____.

Claim(s) discussed: 1, 7, and 8.

Identification of prior art discussed: N/A.

Agreement with respect to the claims f) was reached. g) was not reached. h) N/A.

Substance of Interview including description of the general nature of what was agreed to if an agreement was reached, or any other comments: See Continuation Sheet.

(A fuller description, if necessary, and a copy of the amendments which the examiner agreed would render the claims allowable, if available, must be attached. Also, where no copy of the amendments that would render the claims allowable is available, a summary thereof must be attached.)

THE FORMAL WRITTEN REPLY TO THE LAST OFFICE ACTION MUST INCLUDE THE SUBSTANCE OF THE INTERVIEW. (See MPEP Section 713.04). If a reply to the last Office action has already been filed, APPLICANT IS GIVEN ONE MONTH FROM THIS INTERVIEW DATE, OR THE MAILING DATE OF THIS INTERVIEW SUMMARY FORM, WHICHEVER IS LATER, TO FILE A STATEMENT OF THE SUBSTANCE OF THE INTERVIEW. See Summary of Record of Interview requirements on reverse side or on attached sheet.

Examiner Note: You must sign this form unless it is an Attachment to a signed Office action.


Examiner's signature, if required

Continuation of Substance of Interview including description of the general nature of what was agreed to if an agreement was reached, or any other comments:

Claim1, line 6, after "a light reflector" inserted --wherein the porous silicon layer formed comprises porous silicon parts and columnar conductive parts, said columnar conductive parts forming conductive connections between the substrate and a first region of a semiconductive region--

Claim 7 has been canceled.

Claim 8, line 1, replaced "recited in claim 7" with --recited in claim 1--